



Features

- Date rate 155Mbps
- 1310nm FP laser and PIN photodetector for 40km transmission
- 1550nm uncooled DFB laser and PIN photodetector for 80km transmission
- Digital diagnostic monitor interface compliant with SFF-8472
- SFP MSA package with duplex LC connector
- +3.3V single power supply
- Power consumption less than 1W
- Operating case temperature
 Standard temp:-5~+70°C
 Industrial temp:-40~+85°C
- RoHS compliant

Regulatory Compliance

Table 1 - Regulatory Compliance

Feature	Standard	Performance	
Electrostatic Discharge	MIL-STD-883E	Class 1	
(ESD) to the Electrical Pins	Method 3015.7	Class	
Electrostatic Discharge (ESD) to the	IEC 61000-4-2	Compliant with standard	
Duplex LC Receptacle	1EC 01000-4-2	Compliant with standard	
Electromagnetic	FCC Part 15 Class B	Compliant with standard	
Interference (EMI)	1 CC Fait 13 Class B	Compliant with standard	
	FDA 21CFR 1040.10 and		
Laser Eye Safety	1040.11	Compliant with Class I laser product.	
	EN (IEC) 60825-1,2		
RoHS	2011/65/EU	Compliant with RoHS	

Absolute Maximum Ratings

Table 2 - Absolute Maximum Ratings

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Storage Temperature	Ts	-40	-	+85	°C	
Supply Voltage	V _{CC}	-0.5	-	+3.6	V	
Operating Relative Humidity	RH	+5	-	+95	%	



Recommended Operating Conditions

Table 3 – Recommended Operating Conditions

Parameter		Symbol	Min.	Typical	Max.	Unit	Notes
Operating Case	Standard	т	-5	-	+70	°C	
Temperature	Industrial	T _C	-40	-	+85	°C	
Power Supply Volta	ige	V _{CC}	3.13	3.3	3.47	V	
Power Supply Curr	ent	I _{cc}	-	-	300	mA	
Power Dissipation		P_{D}	-	-	1	W	
Data Rate				155		Mbps	

Table 4 - Optical Characteristics

SP-03-LR1-CDFM SP-03-LR1-IDFM (1310nm FP and PIN, 40km, Monitoring function)

Transmitter										
Parameter Symbol Min. Typical Max. Unit										
Centre Wavelength	λ _C	1263		1360	nm					
Average Output Power	P _{out}	-5		0	dBm	1				
Spectral Width (RMS)	Δλ			3	nm					
Extinction Ratio	EX	10			dB					
Jitter Generation (RMS)				0.01	UI					
Jitter Generation (pk-pk)				0.1	UI					
Optical Eye Mask	Compliar	nt with Telcord	dia GR-253-CC	RE and ITU-1	Г G.957	2				
		Receiver								
Centre Wavelength	λ _C	1260		1580	nm					
Receiver Sensitivity	P _{IN}			-34	dBm	3				
Receiver Overload	P _{IN}	-10			dBm	3				
Optical Path Penalty				1	dB	4				
LOS Assert	LOSA	-45			dBm					
LOS Deassert	LOS _D			-37	dBm					
LOS Hysteresis		0.5		4	dB					

Notes:

- 1. The optical power is launched into SMF.
- 2. Measured with a PRBS 2²³-1 test pattern @155Mbps.
- 3. Measured with a PRBS 2^{23} -1 test pattern @155Mbps, BER $\leq 1 \times 10^{-10}$.
- 4. Measured with a PRBS 2^{23} -1 test pattern @155Mbps, over 40km G.652 SMF, BER $\leq 1 \times 10^{-10}$.



Table 5- Optical Characteristics SP-03-LR2-CDFM SP-03-LR2-IDFM (1550nm DFB and PIN, 80km, Monitoring function)

Transmitter										
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes				
Centre Wavelength	λ _C	1480		1580	nm					
Average Output Power	P _{out}	-5		0	dBm	1				
Spectral Width (-20dB)	Δλ			1	nm					
Side Mode Suppression Ratio	SMSR	30			dB					
Extinction Ratio	EX	10			dB					
Jitter Generation (RMS)				0.01	UI					
Jitter Generation (pk-pk)				0.1	UI					
Optical Eye Mask	Compatib	le with Telcor	dia GR-253-C	ORE and ITU-	T G.957	2				
		Receiver								
Centre Wavelength	λ _C	1260		1580	nm					
Receiver Sensitivity	P _{IN}			-34	dBm	3				
Receiver Overload	P _{IN}	-10			dBm	3				
Optical Path Penalty				1	dB	4				
LOS Assert	LOS _A	-45			dBm					
LOS Deassert	LOS _D			-37	dBm					
LOS Hysteresis		0.5		4	dB					

Notes:

- 1. The optical power is launched into SMF.
- 2. Measured with a PRBS 2²³-1 test pattern @155Mbps.
- 3. Measured with a PRBS 2^{23} -1 test pattern @155Mbps, BER $\leq 1 \times 10^{-10}$.
- 4. Measured with a PRBS 2^{23} -1 test pattern @155Mbps, over 80km G.652 SMF, BER $\leq 1 \times 10^{-10}$.

Electrical Characteristics

Table 6- Electrical Characteristics

Transmitter										
Parameter Symbol Min. Typical Max. Unit No										
Data Input Swing Differential	V _{IN}	500		2400	mV	1				
Input Differential Impedance	Z _{IN}	90	100	110	Ω					
Tx_DIS Disable	V_D	2.0		V _{CC}	V					
Tx_DIS Enable	V _{EN}	GND		GND+0.8	V					
TX_ Fault (Fault)		2.0		Vcc+0.3	V					
TX_ Fault (Normal)		0		0.8	V					



Receiver										
Data Output Swing Differential	V _{OUT}	370		2000	mV	1				
Rx_LOS Fault	$V_{LOS-Fault}$	2.0		Vcc+0.3	V					
Rx_LOS Normal	V _{LOS-Normal}	GND		GND+0.8	V					

Notes:

1. Internally AC coupled

Recommended Host Board Power Supply Circuit

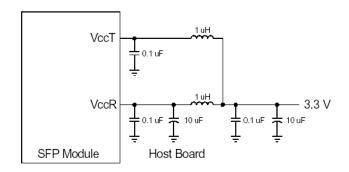


Figure 1, Recommended Host Board Power Supply Circuit

Recommended Interface Circuit

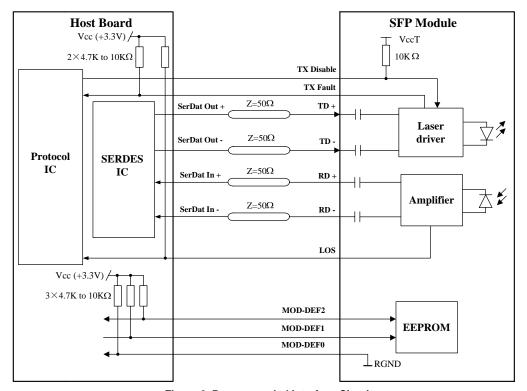


Figure 2, Recommended Interface Circuit



Pin Definitions

Figure 3 below shows the pin numbering of SFP electrical interface. The pin functions are described in Table 7 with some accompanying notes.

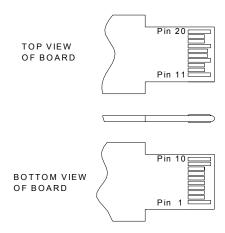


Figure 3, Pin View

Table7 - Pin Function Definitions

Pin No.	Name	Function	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	
2	TX Fault	Transmitter Fault Indication	3	Note 1
3	TX Disable	Transmitter Disable	3	Note 2
4	MOD-DEF2	Module Definition 2	3	Note 3
5	MOD-DEF1	Module Definition 1	3	Note 3
6	MOD-DEF0	Module Definition 0	3	Note 3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	VeeR	Receiver Ground	1	
10	VeeR	Receiver Ground	1	
11	VeeR	Receiver Ground	1	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	VeeR	Receiver Ground	1	
15	VccR	Receiver Power	2	
16	VccT	Transmitter Power	2	
17	VeeT	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	VeeT	Transmitter Ground	1	

Notes:



- TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- 2. TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a 4.7k~10kΩ resistor. Its states are:

Low $(0\sim0.8V)$: Transmitter on (>0.8V, <2.0V): Undefined

High (2.0~3.465V): Transmitter Disabled Open: Transmitter Disabled

- 3. MOD-DEF 0,1,2 are the module definition pins. They should be pulled up with a $4.7k\sim10k\Omega$ resistor on the host board. The pull-up voltage shall be VccT or VccR.
 - MOD-DEF 0 is grounded by the module to indicate that the module is present
 - MOD-DEF 1 is the clock line of two wires serial interface for serial ID
 - MOD-DEF 2 is the data line of two wires serial interface for serial ID
- 4. LOS is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates loss of signal. In the low state, the output will be pulled to less than 0.8V.
- 5. These are the differential receiver output. They are internally AC-coupled 100Ω differential lines which should be terminated with 100Ω (differential) at the user SERDES.
- 6. These are the differential transmitter inputs. They are AC-coupled, differential lines with 100Ω differential termination inside the module.

EEPROM Information

The SFP MSA defines a 256-byte memory map in EEPROM describing the transceiver's capabilities, standard interfaces, manufacturer, and other information, which is accessible over a 2 wire serial interface at the 8-bit address 1010000X (A0h). The memory contents refer to Table 9.

Table 8 - EEPROM Serial ID Memory Contents (A0h)

	Field			
Addr.	Size	Name of Field	Hex	Description
	(Bytes)			
0	1	Identifier	03	SFP
1	1	Ext. Identifier	04	MOD4
2	1	Connector	07	LC
3—10	8	Transceiver	00 xx xx 00 00 00 00 00	OC 3, Single mode inter. or long reach
11	1	Encoding	03	NRZ
12	1	BR, nominal	02	155Mbps
13	1	Reserved	00	
		Length	28/50	
14	1	(9um)-km	20/30	40km/80km
15	1	Length (9um)	FF/FF	40km/80km



4.0			la a	
16	1	Length (50um)		
17	1	Length (62.5um)	00	
18	1	Length (copper)	00	
19	1	Reserved	00	
20—35	16	Vendor name	53 4F 55 52 43 45 50 48	"SOURCEPHOTONICS"(ASC [[)
20—33	2	vendoi name	4F 54 4F 4E 49 43 53 20	SOURCEI HOTORICS (ASCII)
36	1	Reserved	00	
37—39	3	Vendor OUI	00 1F 22	
40—55	16	Vendor PN	53 50 30 33 xx xx xx xx	"SD02voorDEM" (ASC II)
40—55	10	vendor PN	44 46 4D 20 20 20 20 20	"SP03xxxxDFM" (ASC II)
56—59	4	Vendor rev	31 30 20 20	ASC II ("31 30 20 20" means 1.0 revision)
60-61	2	Wavelength	05 1E/06 0E	1310nm/1550nm
62	1	Reserved	00	
63	1	CC BASE	xx	Check sum of bytes 0 - 62
64—65	2	Options	00 1A	LOS, TX_FAULT and TX_DISABLE
66	1	BR, max	00	
67	1	BR, min	00	
68—83	16	Vendor SN	xx xx xx xx xx xx xx xx	ASC II .
00—03	10		xx xx xx xx xx xx xx xx	ASCII.
		Vendor date		Year (2 bytes), Month (2 bytes), Day (2
84—91	8	code	xx xx xx xx xx xx 20 20	bytes)
92	1	Diagnostic type	58	Diagnostics(Ext.Cal)
		Enhanced		Diagnostics (Optional Alarm/warning flags,
93	1		В0	Soft TX_FAULT and Soft TX_LOS
		option		monitoring)
94	1	SFF-8472	02	Diagnostics(SFF-8472 Rev 9.4)
95	1	CC EXT	xx	Check sum of bytes 64 - 94
96—255	160	Vendor specific		

Note: The "xx" byte should be filled in according to practical case. For more information, please refer to the related document of SFF-8472 Rev 9.5.

Monitoring Specification

The digital diagnostic monitoring interface also defines another 256-byte memory map in EEPROM, which makes use of the 8 bit address 1010001X (A2h). Please see Figure 4. For detail EEPROM information, please refer to the related document of SFF-8472 Rev 9.5. The monitoring specification of this product is described in Table 9.



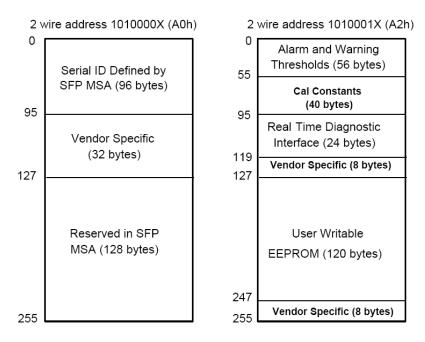


Figure 4, EEPROM Memory Map Specific Data Field Descriptions

Table 9- Monitoring Specification

Para	meter	Range	Accuracy	Calibration	
Temperature	Standard	-10 to 80°C	±3°C	External	
remperature	Industrial	-40 to 95°C	±3°C	External	
Volt	tage	3.0 to 3.6V	±3%	External	
Bias C	Current	0 to 100mA	±10%	External	
	SP-03-LR1-CDFM	-6 to +1 dBm	±3dB	External	
TX Power	SP-03-LR1-IDFM	-0 (0 +1 dbiii	±JUD	External	
TXFOWE	SP-03-LR2-CDFM	-6 to +1 dBm	±3dB	External	
	SP-03-LR2-IDFM	-0 (0 +1 dbiii	±JUD	External	
	SP-03-LR1-CDFM	-34 to –9 dBm	±3dB	External	
RX Power	SP-03-LR1-IDFM	-34 to -9 ubiii	ISUD	External	
KV Lowel	SP-03-LR2-CDFM	-34 to –9 dBm	±2dD	External	
	SP-03-LR2-IDFM	-34 (U –9 UBIII	±3dB	External	



Mechanical Diagram

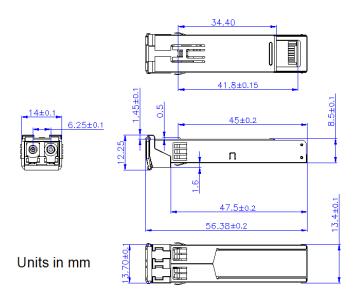


Figure 5, Mechanical Design Diagram of the SFP

Order Information

Table 10- Order Information

Part No.	Application	Temperature	Data Rate	Laser Source	Fiber Type	
SD 02 LD1 CDEM	SDH STM-1, L-1.1	-5~+70°C	155Mbps	1310nm FP	SMF	
SP-03-LR1-CDFM	SONET OC-3 LR1	-5~+70 C	rooiviops	13 1011111 FP	SIVIE	
CD 02 LD4 IDEM	SDH STM-1, L-1.1	40 +05°C	-40~+85°C 155Mb	40 :05°C 455Mbas 4240am FD	1310nm FP	SMF
SP-03-LR1-IDFM	SONET OC-3 LR1	-40~+65 C	155Mbps	13 1011111 FP	SIVIE	
SP-03-LR2-CDFM	SDH STM-1, L-1.2	-5~+70°C	155Mbps	1550nm DFB	SMF	
SP-03-LRZ-CDFW	SONET OC-3 LR2	-5~+70 C	roolvibps	1990IIII DEB	SIVIE	
SP-03-LR2-IDFM	SDH STM-1, L-1.2	-40~+85°C	155Mbpc	1550nm DFB	SMF	
SF-U3-LRZ-IDFIVI	SONET OC-3 LR2	-40~+65 C	155Mbps	1990HIII DEB	SIVIF	

Warnings

Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.

Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.



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